# FP1008R7

## High frequency, high current power inductors



#### **Product features**

- · High current carrying capacity
- · Low core loss
- · Magnetically shielded
- Inductance Range from 100 nH to 180 nH
- Current range from 60 A to 100 A
- 10.8 mm x 8.2 mm footprint surface mount package in an 8.2 mm height
- Moisture Sensitivity Level: 1
- · Ferrite core material

#### **Applications**

- Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs) and high power density VRMs
  - Server and desktop
  - · Central processing unit (CPU)
  - Graphics processing unit (GPU)
  - Application specific integrated circuit (ASIC)
- · Data networking and storage systems
- · Graphics cards and battery power systems
- Point-of-Loadmodules (POL)

#### **Environmental data**

- Storage temperature range (Component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature:
   J-STD-020 (latest revision) compliant
- · Halogen free, lead free, RoHS compliant









#### **Product specifications**

Part Number <sup>8</sup>	OCL <sup>1</sup> (nH) ±10%	FLL <sup>2</sup> (nH) minimum	I <sub>rms</sub> <sup>3</sup> (A)	I <sub>sat</sub> 1 <sup>4</sup> (A)	I <sub>sat</sub> 2 <sup>5</sup> (A)	I <sub>sat</sub> 3 <sup>6</sup> (A)	DCR (mΩ) maximum @ 20°C	K-factor <sup>7</sup>
FP1008R7-R100-R	100	72	72	100	90	84	0.120	361
FP1008R7-R120-R	120	86	72	90	75	70	0.120	361
FP1008R7-R150-R	150	108	72	72	60	56	0.120	361
FP1008R7-R180-R	180	130	72	60	50	46	0.120	361

- 1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.1 Vrms, 0.0 Adc, +25 °C
- 2. Full Load Inductance (FLL) Test Parameters: 100 kHz, 0.1 Vrms, I<sub>sat</sub>1, +25 °C
- 3.  $I_{ms}$ : DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125  $^{\circ}\text{C}$  under worst case operating conditions verified in the
- 4.  $I_{sat}$ 1: Peak current for approximately 20% rolloff @ +25 °C
- $_{\rm lsat}^{--}$ 2: Peak current for approximately 20% rolloff @ +100 °C
- 6. I 3: Peak current for approximately 20% rolloff @ +125 °C

- 7. K-factor: Used to determine  $B_{p,p}$  for core loss (see graph).  $B_{n-n} = K * L * \Delta I * 10^{-3}$ .  $B_{n-n}$ :(Gauss), K: (K-factor from table), L: (Inductance in nH),  $\Delta$ I (Peak to peak ripple current in Amps).
- 8. Part Number Definition: FP1008R7-Rxxx-R

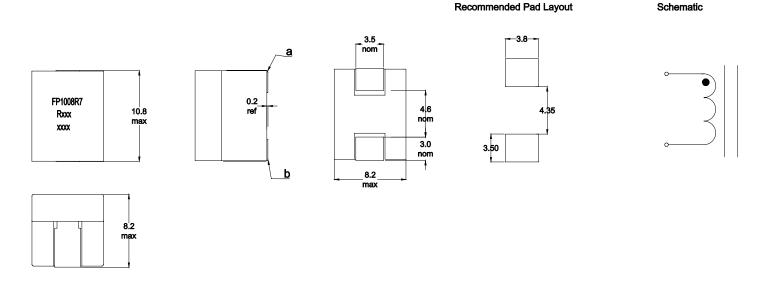
FP1008R7= Product code and size

x= Version indicator

Rxxx= Inductance value in µH, R= decimal point

-R suffix = RoHS compliant

### Dimensions (mm)



Part marking: FP1008R7, Rxxx (xxx=inductance value in uH, R=decimal point), xxxx=Lot code

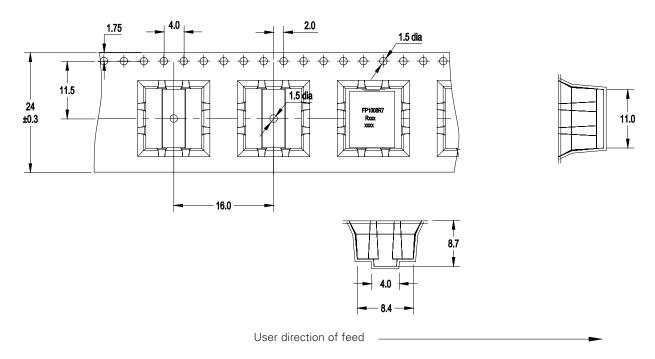
Tolerances are ±0.15 millimeters unless stated otherwise. All soldering surfaces to be coplanar within 0.1 millimeters

Pad layout tolerances are ±0.1 millimeters unless stated otherwise DCR measured from point "a" to point "b"

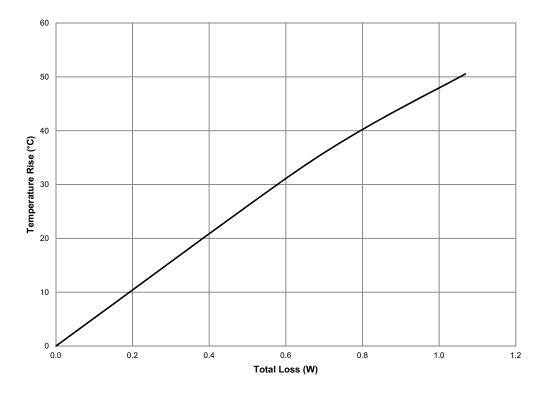
Do not route traces or vias underneath the inductor

## Packaging information (mm)

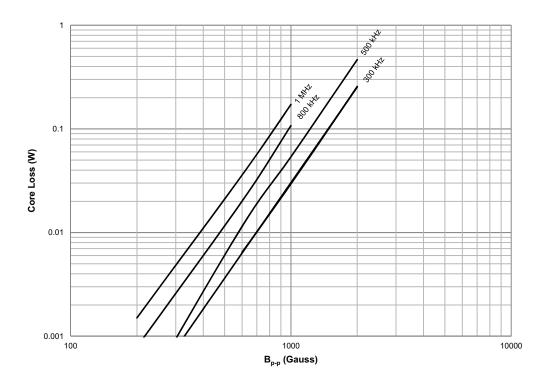
Supplied in tape and reel packaging , 400 parts per 13" diameter reel



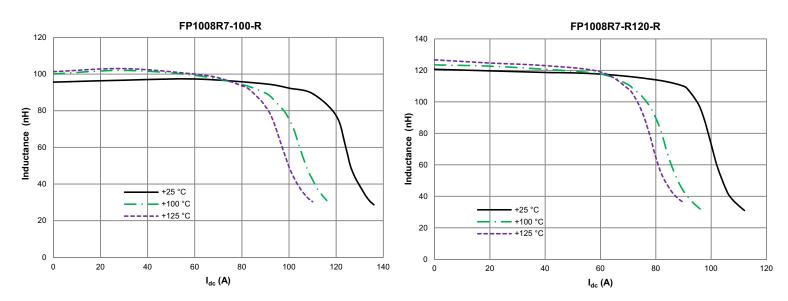
## Temperature rise vs. total loss



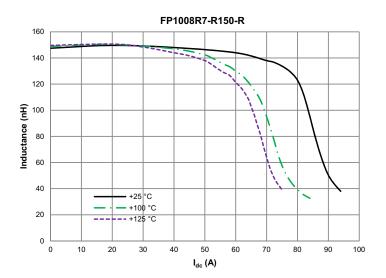
## Core loss vs. B<sub>p-p</sub>

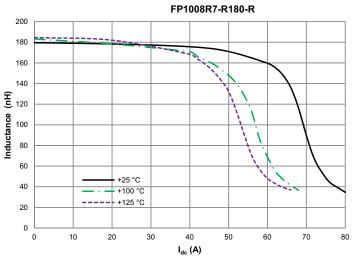


## **Inductance characteristics**



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## Solder reflow profile

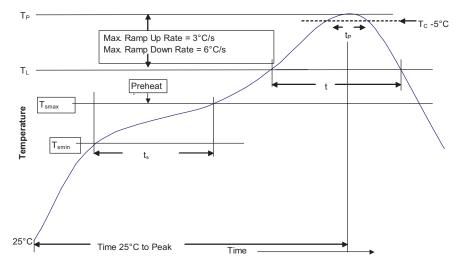


Table 1 - Standard SnPb Solder (T<sub>C</sub>)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm	235 °C	220 °C
≥2.5mm	220 °C	220 °C

Table 2 - Lead (Pb) Free Solder (T<sub>C</sub>)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260 °C	260 °C	260 °C
1.6 – 2.5mm	260 °C	250 °C	245 °C
>2.5mm	250 °C	245 °C	245 °C

### **Reference JDEC J-STD-020**

Standard SnPb Solder	Lead (Pb) Free Solder	
100 °C	150 °C	
150 °C	200 °C	
60-120 Seconds	60-120 Seconds	
3 °C/ Second Max.	3 °C/ Second Max.	
183 °C 60-150 Seconds	217 °C 60-150 Seconds	
Table 1	Table 2	
20 Seconds**	30 Seconds**	
6 °C/ Second Max.	6 °C/ Second Max.	
6 Minutes Max.	8 Minutes Max.	
	100 °C 150 °C 60-120 Seconds 3 °C/ Second Max. 183 °C 60-150 Seconds Table 1 20 Seconds** 6 °C/ Second Max.	

 $<sup>^{*}</sup>$  Tolerance for peak profile temperature (T $_{\rm p}$ ) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup> Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.